





Impedance Matched Ultra Low profile 0805 Balun for TI CC1101/1100 chipset (Anaren Application Note Ann-2005)

Description

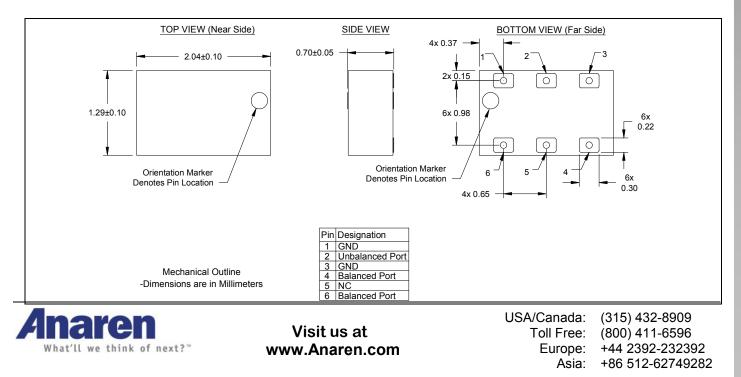
The B0809J50ATI is a low cost, low profile sub-miniature unbalanced to balanced transformer specifically designed for differential inputs and output locations Texas Instruments CC1100 and CC1101 SoC Solution in an easy to use surface mount package. The B0809J50ATI is ideal for high volume manufacturing and delivers higher performance than traditional ceramic baluns. This transformation enables single ended signals to be applied to differential ports on the CC1100/CC1101. The output ports have equal amplitude (-3dB) with 180 degree phase differential. The B0809J50ATI is available on tape and reel for pick and place high volume manufacturing.

Detailed Electrical Specifications: Specifications subject to change without notice.

Features:		ROOM (25°C)			
• 850 – 915 MHz	Parameter	Min.	Тур.	Мах	Unit
 Matched to TI CC1100 & CC1101 SoC 	Frequency	850		915	MHz
0.7mm Height Profile	Unbalanced Port Impedance*		50		Ω
Low Insertion Loss	Balanced Port Impedance*		Matched		Ω
Surface Mountable	Return Loss*	15.3	18.0		dB
 Tape & Reel Non-conductive Top Surface 	Insertion Loss**		0.5	0.6	dB
RoHS Compliant	Power Handling			2.0	Watts
Zigbee, RF4CE					
Halogen Free	Operating Temperature	-55		+85	°C

*Specification based on performance of unit properly installed on microstrip printed circuit boards according to Anaren application note Ann-2005. ** Insertion Loss stated at room temperature (Insertion Loss is approximately 0.1dB higher at +85°C

Outline Drawing



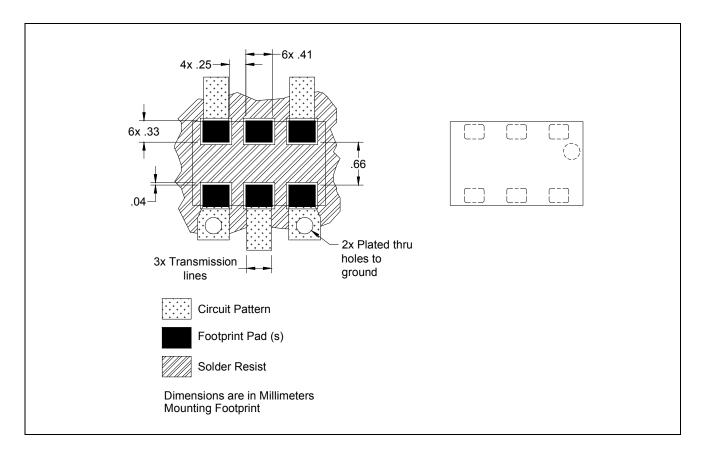


Mounting Configuration:

In order for Xinger surface mount components to work optimally, the proper impedance transmission lines must be used to connect to the RF ports. If this condition is not satisfied, insertion loss, Isolation and VSWR may not meet published specifications.

All of the Xinger components are constructed from organic PTFE based composites which possess excellent electrical and mechanical stability. Xinger components are compliant to a variety of ROHS and Green standards and ready for Pb-free soldering processes. Pads are Gold plated with a Nickel barrier.

An example of the PCB footprint used in the testing of these parts is shown below. In specific designs, the transmission line widths need to be adjusted to the unique dielectric coefficients and thicknesses as well as varying pick and place equipment tolerances.



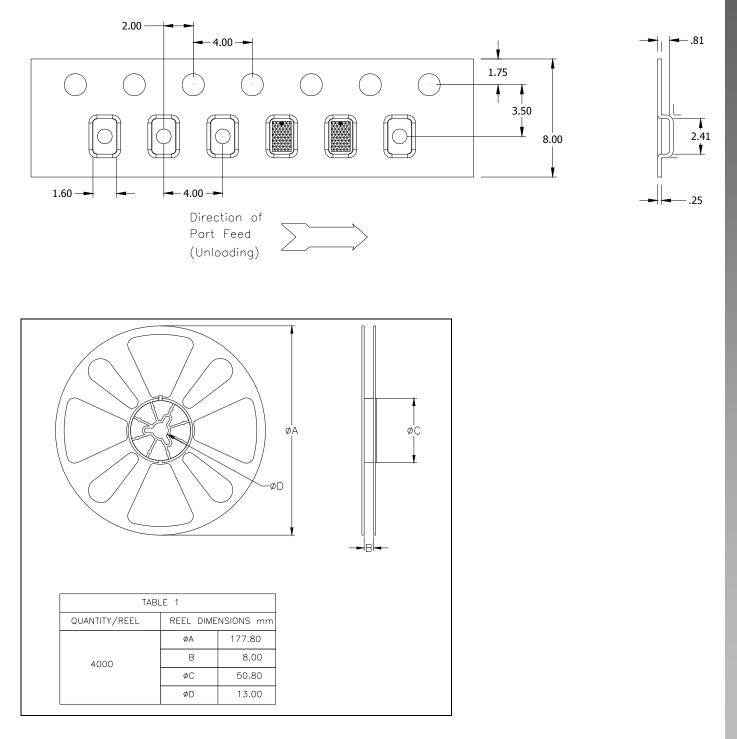


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Packaging and Ordering Information

Parts are available in reel and are packaged per EIA 481-2. Parts are oriented in tape and reel as shown below. Minimum order quantities are 4000 per reel. See Model Numbers below for further ordering information.





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